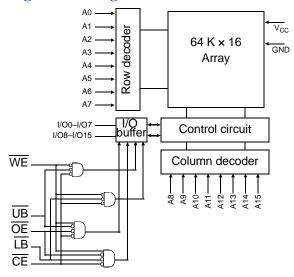


Features

- Industrial and commercial versions
- Organization: 65,536 words \times 16 bits
- Center power and ground pins for low noise
- High speed
 - 10/12/15/20 ns address access time
 - 5, 6, 7, 8 ns output enable access time
- Low power consumption: ACTIVE
 - 605 mW / max @ 10 ns
- Low power consumption: STANDBY
 - 55 mW / max CMOS I/O
- 6 T 0.18 u CMOS technology
- Easy memory expansion with \overline{CE} , \overline{OE} inputs

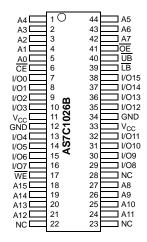
Logic block diagram



- TTL-compatible, three-state I/O
- JEDEC standard packaging
- 44-pin 400 mil SOJ
- 44-pin TSOP 2-400
- ESD protection ≥ 2000 volts
- Latch-up current ≥ 200 mA

Pin arrangement

44-Pin SOJ (400 mil), TSOP 2



Selection guide

	-10	-12	-15	-20	Unit
Maximum address access time	10	12	15	20	ns
Maximum output enable access time	5	6	7	8	ns
Maximum operating current	110	100	90	80	mA
Maximum CMOS standby current	10	10	10	10	mA



Functional description

The AS7C1026B is a high-performance CMOS 1,048,576-bit Static Random Access Memory (SRAM) device organized as 65,536 words × 16 bits. It is designed for memory applications where fast data access, low power, and simple interfacing are desired.

Equal address access and cycle times (t_{AA} , t_{RC} , t_{WC}) of 10/12/15/20 ns with output enable access times (t_{OE}) of 5, 6, 7, 8 ns are ideal for high-performance applications.

When $\overline{\text{CE}}$ is high, the device enters standby mode. If inputs are still toggling, the device will consume I_{SB} power. If the bus is static, then full standby power is reached (I_{SB1}). For example, the AS7C1026B is guaranteed not to exceed 55 mW under nominal full standby conditions.

A write cycle is accomplished by asserting write enable (\overline{WE}) and chip enable (\overline{CE}). Data on the input pins I/O0 through I/O15 is written on the rising edge of \overline{WE} (write cycle 1) or \overline{CE} (write cycle 2). To avoid bus contention, external devices should drive I/O pins only after outputs have been disabled with output enable (\overline{OE}) or write enable (\overline{WE}).

A read cycle is accomplished by asserting output enable (\overline{OE}) and chip enable (\overline{CE}) with write enable (\overline{WE}) high. The chip drives I/O pins with the data word referenced by the input address. When either chip enable or output enable is inactive or write enable is active, output drivers stay in high-impedance mode.

The device provides multiple center power and ground pins, and separate byte enable controls, allowing individual bytes to be written and read. \overline{LB} controls the lower bits, I/O0 through I/O7, and \overline{UB} controls the higher bits, I/O8 through I/O15.

All chip inputs and outputs are TTL-compatible, and operation is from a single 5 V supply. The device is packaged in common industry standard packages.

Absolute maximum ratings

Parameter	Symbol	Min	Max	Unit
Voltage on V _{CC} relative to GND	V _{t1}	-0.50	+7.0	V
Voltage on any pin relative to GND	V _{t2}	-0.50	V _{CC} +0.50	V
Power dissipation	P_{D}	_	1.0	W
Storage temperature (plastic)	T _{stg}	-65	+150	°C
Ambient temperature with VCC applied	T _{bias}	-55	+125	°C
DC current into outputs (low)	I _{OUT}	_	20	mA

Note: Stresses greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Truth table

CE	WE	OE	LB	UB	I/O0–I/O7	I/O8–I/O15	Mode
Н	X	X	X	X	High Z	High Z	Standby (I _{SB}), I _{SBI})
L	Н	L	L	Н	D _{OUT}	High Z	Read I/O0–I/O7 (I _{CC})
L	Н	L	Н	L	High Z	D _{OUT}	Read I/O8–I/O15 (I _{CC)}
L	Н	L	L	L	D _{OUT}	D _{OUT}	Read I/O0–I/O15 (I _{CC})
L	L	X	L	L	D _{IN}	D _{IN}	Write I/O0–I/O15 (I _{CC})
L	L	X	L	Н	D _{IN}	High Z	Write I/O0–I/O7 (I _{CC})
L	L	X	Н	L	High Z	D _{IN}	Write I/O8–I/O15 (I _{CC})
L L	H X	H X	X H	X H	High Z	High Z	Output disable (I _{CC})

Key: H = high, L = low, X = don't care.



Recommended operating conditions

Parameter	Symbol	Min	Nominal	Max	Unit	
Supply voltage	V _{CC}	4.5	5.0	5.5	V	
Input voltage	V _{IH}	2.2	_	V _{CC} + 0.5	V	
input voltage	V_{IL}	-0.5	-	0.8	V	
Ambient operating temperature	commercial	T_{A}	0	_	70	° C
Ambient operating temperature	industrial	T_{A}	-40	_	85	° C

 V_{IL} min = -1.0V for pulse width less than 5ns

DC operating characteristics (over the operating range) I

			-1	-10		2	-1	15	-20		
Parameter	Sym	Test conditions	Min	Max	Min	Max	Min	Max	Min	Max	Unit
Input leakage current	I _{LI}	$V_{CC} = Max,$ $V_{IN} = GND \text{ to } V_{CC}$	_	1	_	1	_	1	-	1	μΑ
Output leakage current	I _{LO}	$V_{CC} = Max, \overline{CE} = V_{IH},$ $V_{OUT} = GND \text{ to } V_{CC}$	_	1	_	1		1	-	1	μΑ
Operating power supply current	I_{CC}	$\begin{aligned} & V_{CC} = Max, \\ & \overline{CE} \leq V_{IL}, I_{OUT} = 0mA, \\ & f = f_{Max} \end{aligned}$	_	110	_	100	-	90	-	80	mA
	I_{SB}	$V_{CC} = Max,$ $\overline{CE} \ge V_{IH, f} = f_{Max}$	_	50	_	45	ı	45		40	mA
Standby power supply current	I_{SB1}	$V_{CC} = \text{Max}, \overline{\text{CE}} \ge V_{CC} - 0.2 \text{ V},$ $V_{IN} \le 0.2 \text{ V or}$ $V_{IN} \ge V_{CC} - 0.2 \text{ V}, f = 0$	_	10	_	10	ı	10	-	10	mA
Output voltage	V _{OL}	$I_{OL} = 8 \text{ mA}, V_{CC} = \text{Min}$	_	0.4	_	0.4	-	0.4	-	0.4	V
Output voltage	V _{OH}	$I_{OH} = -4 \text{ mA}, V_{CC} = \text{Min}$	2.4	-	2.4	_	2.4	_	2.4	-	V

Capacitance (f = 1MHz, $T_a = 25$ °C, $V_{CC} = NOMINAL$)²

Parameter	Symbol	Signals	Test conditions	Max	Unit
Input capacitance	C_{IN}	$A, \overline{CE}, \overline{WE}, \overline{OE}, \overline{LB}, \overline{UB}$	$V_{IN} = 0 V$	5	pF
I/O capacitance	C _{I/O}	I/O	$V_{IN} = V_{OUT} = 0 V$	7	pF

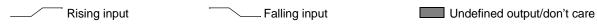
 V_{IH} max = V_{CC} +2.0V for pulse width less than 5ns.



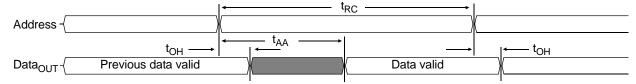
Read cycle (over the operating range)^{3,9}

		-1	0	-1	2	-1	.5	-2	0		
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Notes
Read cycle time	t _{RC}	10	_	12	_	15	_	20	-	ns	
Address access time	t _{AA}	_	10	_	12	_	15	-	20	ns	3
Chip enable (CE) access time	t _{ACE}	_	10	_	12	_	15	-	20	ns	3
Output enable (OE) access time	t _{OE}	_	5	_	6	_	7	-	8	ns	
Output hold from address change	t _{OH}	3	_	3	_	3	_	3	-	ns	5
CE low to output in low Z	t _{CLZ}	3	_	3	_	3	_	3	-	ns	4, 5
TE high to output in high Z	t _{CHZ}	_	4	_	5	_	6	-	7	ns	4, 5
OE low to output in low Z	t _{OLZ}	0	_	0	_	0	_	0	-	ns	4, 5
Byte select access time	t _{BA}	_	5	_	6	_	7	-	8	ns	
Byte select Low to low Z	t _{BLZ}	0	_	0	_	0	_	0	-	ns	4, 5
Byte select High to high Z	t _{BHZ}	_	5	_	6	_	6	-	7	ns	4, 5
OE high to output in high Z	t _{OHZ}	_	4	_	5	_	6	-	7	ns	4, 5
Power up time	t _{PU}	0	_	0	_	0	_	0	-	ns	4, 5
Power down time	t _{PD}	_	10	_	12	_	15	-	20	ns	4, 5

Key to switching waveforms

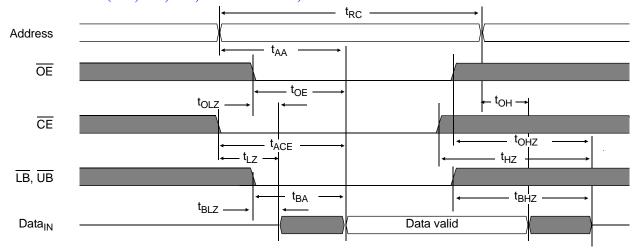


Read waveform 1 (address controlled)^{3,6,7,9}





Read waveform 2 (\overline{OE} , \overline{CE} , \overline{UB} , \overline{LB} controlled)^{3,6,8,9}

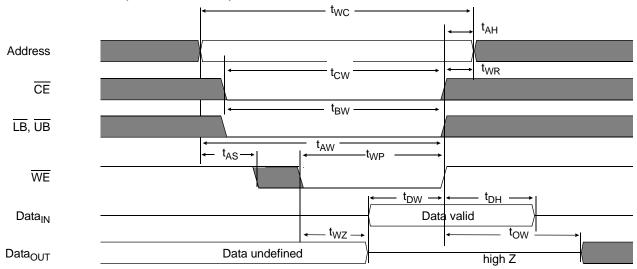


Write cycle (over the operating range) 11

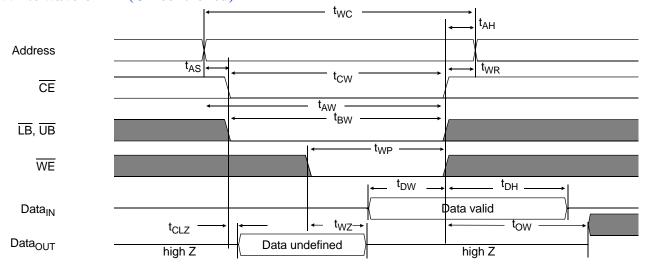
		-1	10	-12				-72	-20		
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Notes
Write cycle time	t _{WC}	10	_	12	_	15	-	20	-	ns	
Chip enable (CE) to write end	t _{CW}	8	_	9	_	10	_	12	-	ns	
Address setup to write end	t _{AW}	8	_	9	_	10	_	12	-	ns	
Address setup time	t _{AS}	0	_	0	_	0	_	0	-	ns	
Write pulse width	t_{WP}	7	_	8	_	9	_	12	-	ns	
Write recovery time	t_{WR}	0	_	0	_	0	-	0	-	ns	
Address hold from end of write	t _{AH}	0	_	0	_	0	_	0	-	ns	
Data valid to write end	t_{DW}	5	_	6	_	8	_	10	-	ns	
Data hold time	t _{DH}	0	_	0	_	0	-	0	-	ns	5
Write enable to output in high Z	t_{WZ}	_	5	_	6	_	7	-	8	ns	4, 5
Output active from write end	t_{OW}	1	_	1	_	1	-	2	-	ns	4, 5
Byte select low to end of write	t _{BW}	7	_	8	_	9	_	9	-	ns	



Write waveform 1 ($\overline{\text{WE}}$ controlled) II



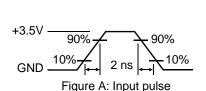
Write waveform 2 ($\overline{\text{CE}}$ controlled)¹¹





AC test conditions

- Output load: see Figure B.
- Input pulse level: GND to 3.5 V. See Figure A.
- Input rise and fall times: 2 ns. See Figure A.
- Input and output timing reference levels: 1.5



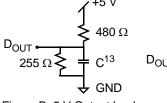


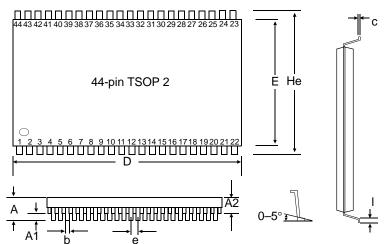
Figure B: 5 V Output load

Notes

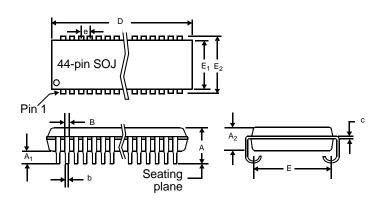
- 1 During V_{CC} power-up, a pull-up resistor to V_{CC} on \overline{CE} is required to meet I_{SB} specification.
- 2 This parameter is sampled, but not 100% tested.
- 3 For test conditions, see AC Test Conditions, Figures A and B.
- 4 These parameters are specified with C_L = 5 pF, as in Figures B. Transition is measured \pm 500 mV from steady-state voltage.
- 5 This parameter is guaranteed, but not tested.
- $\overline{\text{WE}}$ is high for read cycle.
- 7 $\overline{\text{CE}}$ and $\overline{\text{OE}}$ are low for read cycle.
- 8 Address is valid prior to or coincident with $\overline{\text{CE}}$ transition low.
- 9 All read cycle timings are referenced from the last valid address to the first transitioning address.
- 10 N/A.
- 11 All write cycle timings are referenced from the last valid address to the first transitioning address.
- 12 Not applicable.
- 13 C = 30 pF, except all high Z and low Z parameters where C = 5 pF.



Package dimensions



	44-pin 7	TSOP 2				
	Min	Max				
	(mm)	(mm)				
A		1.2				
A1	0.05	0.15				
A2	0.95	1.05				
b	0.30	0.45				
c	0.120	0.21				
D	18.31	18.52				
E	10.06	10.26				
Не	11.68	11.94				
e	0.80 (typical)					
l	0.40	0.60				



	-	44-pin SOJ 400 mil							
	Min (in)	Max (in)							
A	0.128	0.148							
A ₁	0.025	_							
A ₂	0.105	0.115							
В	0.026	0.032							
b	0.015	0.020							
c	0.007	0.013							
D	1.120	1.130							
E	0.370	NOM							
$\mathbf{E_1}$	0.395	0.405							
$\mathbf{E_2}$	0.435	0.445							
e	0.050	NOM							



Ordering codes

Package \ Access time	Temp	10 ns	12 ns	15 ns	20 ns
Plastic SOJ, 400 mil	commercial	AS7C1026B-10JC	AS7C1026B-12JC	AS7C1026B-15JC	AS7C1026B-20JC
	industrial	AS7C1026B-10JI	AS7C1026B-12JI	AS7C1026B-15JI	AS7C1026B-20JI
TSOP 2, 10.2 x 18.4 mm	commercial	AS7C1026B-10TC	AS7C1026B-12TC	AS7C1026B-15TC	AS7C1026B-20TC
1501 2, 10.2 x 10.4 mm	industrial	AS7C1026B-10TI	AS7C1026B-12TI	AS7C1026B-15TI	AS7C1026B-20TI

Note: Add suffix 'N' to the above ordering part number for LEAD FREE PARTS (Ex: AS7C1026B-10JCN)

Part numbering system

AS7C	1026B	-XX	X	X	X
SRAM prefix	Device number	tima		Temperature range: C = commercial: 0° C to 70° C I = industrial: -40° C to 85° C	N = LEAD FREE PART





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Part Number: AS7C1026B

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AS7C1026B-20TCNTR AS7C1026B-15JCNTR AS7C1026B-20JCN AS7C1026B-10TCN AS7C1026B-12TCNTR

AS7C1026B-15JCN AS7C1026B-20JCNTR AS7C1026B-15TCNTR AS7C1026B-15TCN AS7C1026B-20TCN

AS7C1026B-12JCNTR AS7C1026B-10TIN AS7C1026B-10TINTR AS7C1026B-12JIN AS7C1026B-12JINTR

AS7C1026B-12TIN AS7C1026B-12TINTR AS7C1026B-15TINTR AS7C1026B-15TINTR AS7C1026B-20TIN

AS7C1026B-20TINTR